# VSMY98545DS



**Vishay Semiconductors** 

# High Power Infrared Emitting Diode, 850 nm, Surface Emitter Technology



## DESCRIPTION

As part of the <u>SurfLight<sup>TM</sup></u> portfolio, the VSMY98545DS is an infrared, 850 nm emitting diode based on surface emitter technology with high radiant power and high speed, molded in low thermal resistance SMD package with lens. A 42 mil chip provides outstanding radiant intensity and allows DC operation of the device up to 1 A. Superior ESD characteristics are ensured by an integrated Zener diode.

## FEATURES

- Package type: surface mount
- Double stack technology
- Package form: high power SMD with lens
- Dimensions (L x W x H in mm): 3.85 x 3.85 x 2.24
- Peak wavelength:  $\lambda_p = 850 \text{ nm}$
- Zener diode for ESD protection up to 2 kV
- High radiant power
- High radiant intensity
- Angle of half intensity:  $\phi = \pm 45^{\circ}$
- Designed for high drive currents: up to 1 A (DC) and up to 5 A pulses
- Low thermal resistance: R<sub>thJP</sub> = 10 K/W
- Floor life: 168 h, MSL 3, acc. J-STD-020
- Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **APPLICATIONS**

- Infrared illumination for CMOS cameras (CCTV)
- Illumination for cameras (3D gaming)
- Machine vision
- 3D TV

### PRODUCT SUMMARY

COMPONENT	l <sub>e</sub> (mW/sr)	φ (deg)	λ <sub>p</sub> (nm)	t <sub>r</sub> (ns)	
VSMY98545DS	600	± 45	850	30	

### Note

Test conditions see table "Basic Characteristics"

ORDERING INFORMATI	ON		
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM
VSMY98545DS	Tape and reel	MOQ: 600 pcs, 600 pcs/reel	High power with lens

### Note

• MOQ: minimum order quantity

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage		V <sub>R</sub>	5	V	
Forward current		I <sub>F</sub>	1	А	
Peak forward current	$t_p/T = 0.5, t_p = 100 \ \mu s$	I <sub>FM</sub>	2	А	
Surge forward current	t <sub>p</sub> = 100 μs	I <sub>FSM</sub>	5	А	
Power dissipation		Pv	3.6	W	
Junction temperature		Тj	125	°C	
Operating temperature range		T <sub>amb</sub>	-40 to +110	°C	
Storage temperature range		T <sub>stg</sub>	-40 to +125	°C	
Soldering temperature	Acc. figure 10, J-STD-20	T <sub>sd</sub>	260	°C	
Thermal resistance junction/pin	Acc. J-STD-051, soldered on PCB	R <sub>thJP</sub>	10	K/W	

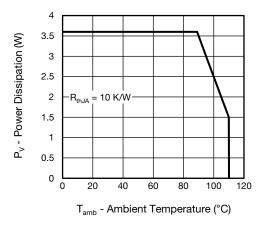
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COMPLIANT HALOGEN

GREEN (5-2008)





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Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

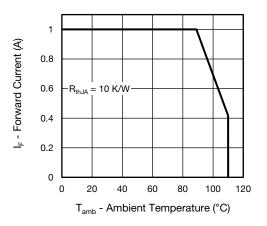


Fig. 2 - Forward Current Limit vs. Ambient Temperature

<b>BASIC CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Ferrier duration of	I <sub>F</sub> = 1 A, t <sub>p</sub> = 20 ms	V <sub>F</sub>		3.2	3.6	V
Forward voltage	I <sub>F</sub> = 5 A, t <sub>p</sub> = 100 μs	V <sub>F</sub>		4.6		V
Temperature coefficient of $V_F$	I <sub>F</sub> = 1 A	TK <sub>VF</sub>		-2.2		mV/K
Reverse current	V <sub>R</sub> = 5 V	I <sub>R</sub>			10	μA
De die staiste se it.	I <sub>F</sub> = 1 A, t <sub>p</sub> = 20 ms	l <sub>e</sub>	300	600	900	mW/sr
Radiant intensity	I <sub>F</sub> = 5 A, t <sub>p</sub> = 100 μs	l <sub>e</sub>		2800		mW/sr
Radiant power	I <sub>F</sub> = 1 A, t <sub>p</sub> = 20 ms	фе		1070		mW
Temperature coefficient of $\phi_{e}$	I <sub>F</sub> = 1 A	TKφ <sub>e</sub>				%/K
Angle of half intensity		φ		± 45		deg
Peak wavelength	I <sub>F</sub> = 1 A	λρ	830	850	870	nm
Spectral bandwidth	I <sub>F</sub> = 1 A	Δλ		50		nm
Temperature coefficient of $\lambda_p$	I <sub>F</sub> = 1 A	ΤΚλ <sub>p</sub>		0.3		nm/K
Rise time	I <sub>F</sub> = 1 A	t <sub>r</sub>		30		ns
Fall time	I <sub>F</sub> = 1 A	t <sub>f</sub>		30		ns

# **VSMY98545DS**



## **Vishay Semiconductors**

## BASIC CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

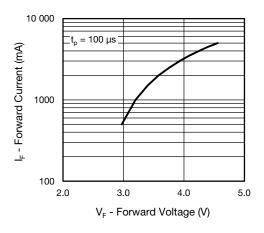


Fig. 3 - Forward Current vs. Forward Voltage

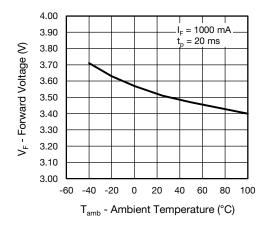


Fig. 4 - Forward Voltage vs. Ambient Temperature

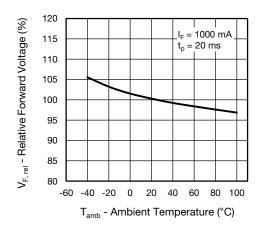


Fig. 5 - Relative Forward Voltage vs. Ambient Temperature

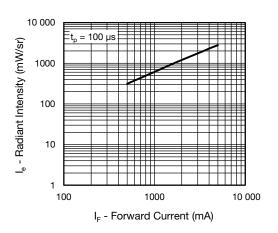


Fig. 6 - Radiant Intensity vs. Forward Current

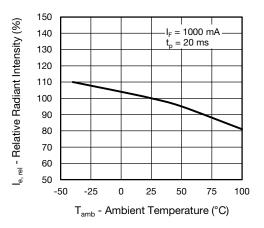


Fig. 7 - Relative Radiant Intensity vs. Ambient Temperature

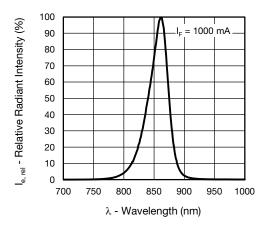


Fig. 8 - Relative Radiant Intensity vs. Wavelength

**3** For technical questions, contact: <u>emittertechsupport@vishay.com</u>

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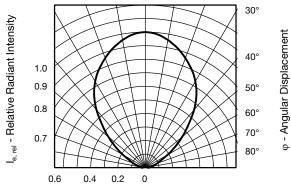
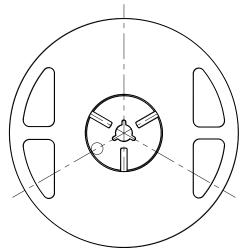
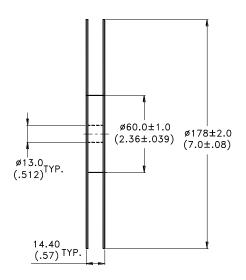


Fig. 9 - Relative Radiant Intensity vs. Angular Displacement

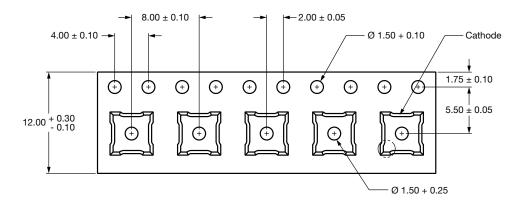
### TAPING DIMENSIONS in millimeters





### Notes

- Empty component pockets sealed with top cover tape.
- 7 inch reel 600 pieces per reel.
- The maximum number of consecutive missing lamps is two.
- In accordance with ANSI/EIA 481-1-A-1994 specifications.

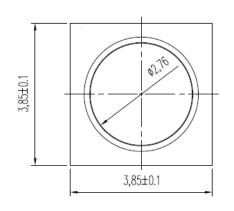


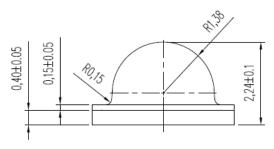
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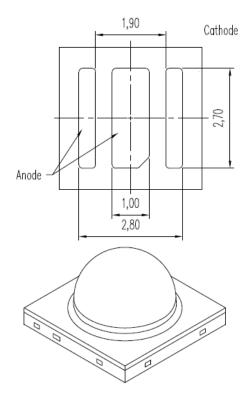
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## **PACKAGE DIMENSIONS** in millimeters

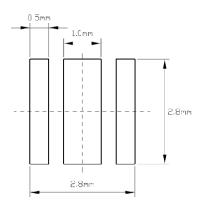




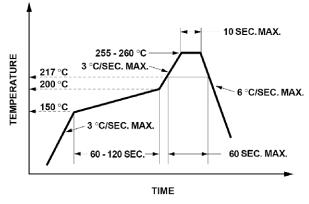


### Notes

- Tolerance is  $\pm$  0.10 mm (0.004") unless otherwise noted.
- Specifications are subject to change without notice.



## SOLDER PROFILE



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Fig. 10 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

### DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

### FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 168 h

Conditions:  $T_{amb}$  < 30 °C, RH < 60 %

Moisture sensitivity level 3, acc. to J-STD-020B

### DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.



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